



10120 Houston Oaks Dr., Houston, TX 77064

Phone: +1(281) 949 1023 Website: tmk-ipsco.com Fax: +1(281) 445 4040

Section 1: Executive Summary

Report Date: December 12, 2018

<u>Test Dates:</u> October 22, 2018 – November 17,2018

TMK–Premium Services

Client: Morozova Str. 30, Taganrog, RUSSIA 347928

Project Number: RDP-105-18-1017

Pipe Specifications: 13.375 ln. OD-72 lb.-P110

Connection Identification:

Connection Specifications and Ratings					
Connection OD:	14.375 in				
Connection Length:	1:	2.205 in			
Make - Up Loss:	5	5.984 in			
Drift:	1:	2.159 in			
Connection ID:	1:	2.291 in			
Thread Compound Used:	BESTOLIFE 72733				
Torque (min. /opt. /max.):	43,100 / 47,9	900 / 52,700 ft-lbs			
	Connection data sheet ratings	Min. Test Rating (% of PBYS)			
API Burst Pressure:	7,390 psi	(100%)			
API Collapse Pressure:	2,890 psi	(100%)			
Tensile Load:	2,285,000 lbs (95%)				
Compression Load:	1,828,000 lbs (80%)				
Bending (Dogleg):	22° / 100 ft	10° / 100 ft			

Table 1-1: Connection Specifications

TMK IPSCO Confidential and Proprietary Information	TEST:			PG:
	TMK UP CENTUM 13.375X72 P110			1 1 of 1 10
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Specimen Preparation & Test Locations

Mechanical Property Testing:	TMK-IPSCO R&D Center, 10120 Houston Oaks Dr., Houston, TX 77064		
Specimen Machining and Surface Treatments:	Custom Threading (CTI), 5835 Cheswood, Houston, TX 77087		
Make and Breaks:	TMK-IPSCO R&D Center, 10120 Houston Oaks Dr., Houston, TX 77064		
Sealability (Series B):	Stress Engineering Services (SES), 42403 Old Houston Highway, Waller, TX 77484		

Table 1-2: Specimen Preparation and Test Locations

Test Procedure

Test Type: CAL IV Series B (1 specimen rehearsal)

Planned deviations from API RP

5C5:

Testing is planned for Specimen 1 only

Additional M&B Cycle on B-side

Number of Specimens: 1 (Specimen 1)

Test Temperatures: 96°F (35.5°C) for Ambient Temperature Testing

356 °F (180 °C) for Elevated Temperature

Testing/ Bake Out

Test Pressure Medium: Nitrogen Gas

Testing Dates & Location

Specimen	Make & Break	Bake-Out	Series B (90/60)	Series B (100/80)
Location	TMK IPSCO	SES	SES	SES
1	10/22/2018	11/01/2018	11/12/2018	11/17/2018

Table 1-3: Test Schedule

Identification of Test Personnel

Engineer in Charge (EIC): Alexey Prokofyev

Project Manager: Manish Nawal, Ryan Schmidt (SES)

Test Engineer: Kevin Henry

Technicians: Donald Anderson, Christopher Coode, Henry Divin (SES),

Tod Phillips (SES), and Steve Busa (SES)

	TEST: TMK UP CENTUM 13.375X72 P110			PG:
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3rd Party Monitoring

Not Applicable

Deviations and Anomalies

Specimen 1 Test Series B (first test) – At Load Step (LS) 218, leak-tube displacement (1.4 cc) exceeded the API criterion during the 10-minute hold. The hold was then extended to a 15- minute hold and then by a series of rolling 5-minute holds per API 5C5. Leak-tube displacement during the final three 5-minute holds (0.2 cc) was within the API criterion, with a total extended hold time of 20 minutes. The test was then continued.

Testing Summary

Specimen Preparation

Test specimens were machined from Tenaris (Heat# 77296) casing stock and Valourec (Heat# 218816) coupling stock. The pins were machined according to drawing no: TMK UP CENTUM 340.001 V13, Revision 1 and couplings were machined according to drawing no: TMK UP CENTUM 340.002 V13, Revision 1. All test specimens satisfied the thread and seal interference ranges outlined in API RP 5C5:2017.

Specimen/Side	Box Finish	Pin Finish
Specimen 1	Zn Phosphate	As Machined

Table 1-4: End Surface Finish

Make & Break Testing

Test specimens were made up using horizontal tongs with 2.0 max RPM. API modified thread compound (BestOLife 72733) per the quantities listed in Table 1-5 were used.

	Dope Quantity on Pin (g)	Dope Quantity on box (g)
Minimum	28±1	57±1
Maximum	33±1	69±1

Table 1-5: Make & Break Dope Quantity

Recommended torque values ranged between 43,100 and 52,700 ft-lb (58,500 and 71,500 N.m). A detailed description of the recommended make—up torque ranges are indicated in Table 1-6. Make—up and break-out cycles for each full-scale test specimen are shown in Table 1-7.

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	Nm		ft-lb	
Minimum recommended torque	58,500		00 43,100	
Optimum recommended torque	65,000		47,900	
Maximum recommended torque	71,500		52,700	
	Minimum	Maximum	Minimum	Maximum
High Make-Up Torque range	68,900	71,500	50,900	52,800
Low Make-Up Torque range	58,500	61,100	43,200	45,100

Table 1-6: Make-Up Torque Ranges

Specimen #	End A	End B
1	FMU	3+FMU

Table 1-7: Make-up and break-out cycles

Bake out

Specimen 1 was baked out at 375°F (190°C) for 24 hours with Load cycles as shown in Table 1-8.

Cycle	Machine Load, kips	Internal Pressure. psi	Hold time	Temperature		
	Heating up to 180±15°C (356 ±27°F)					
1	1300		1 hour			
'	-1000		1 hour			
2	1300		1 hour			
	-1000		1 hour			
3	1300	0	1 hour	180±15°C		
3	-1000		1 hour	(356±27°F)		
4	1300		1 hour			
4	-1000		1 hour			
5	1300		1 hour			
ິວ	-1000		1 hour			

Table 1-8: Bake-Out Cycles

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Sealability Testing

The load ratings specified in Table 1-1 were used on specimen 1. The applied loads (tension/compression) and pressures for each specimen assembly are provided in Figure 1-1 through **Error! Reference source not found.** All specimens met the displacement requirements per API RP 5C5:2017.

Series B: Specimen 1 (90% Tension, 60% Compression)

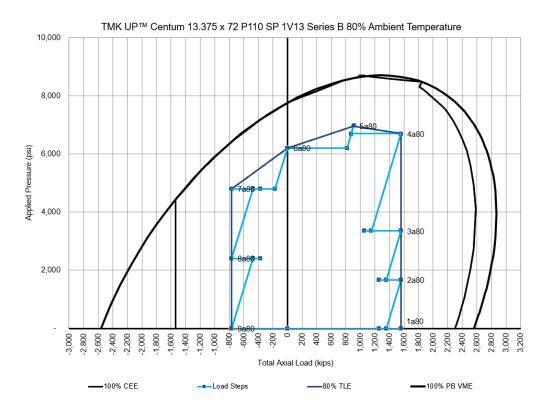


Figure 1-1: Test Envelope for TMK UP Centum Specimen 1 Series B (80% Ambient)

		TEST:			PG:
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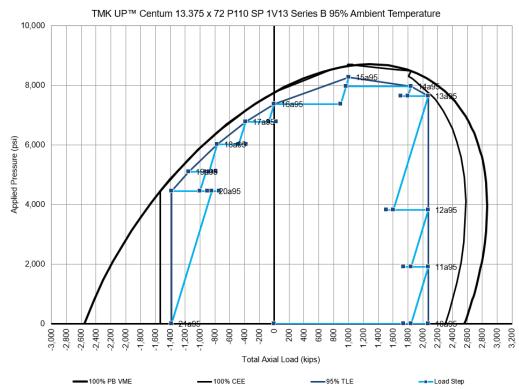


Figure 1-2: Test Envelope for TMK UP Centum Specimen 1 Series B (95% Ambient)

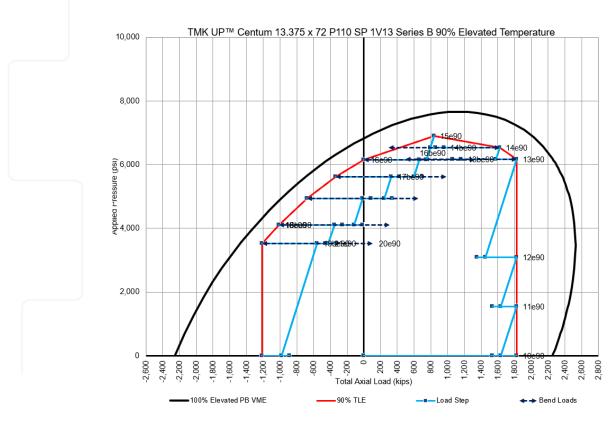


Figure 1-3: Test Envelope for TMK UP Centum Specimen 1 Series B (90% Elevated)

	TEST:			PG:
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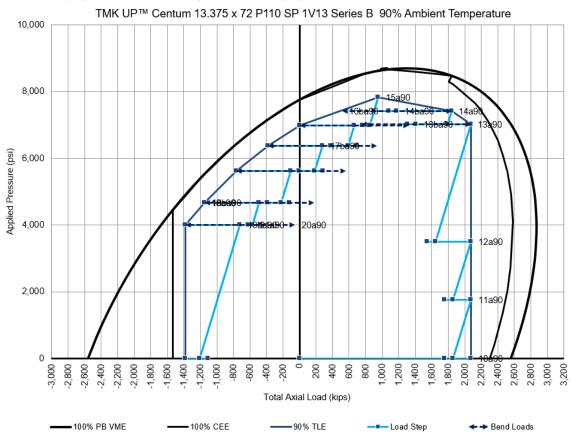


Figure 1-4: Test Envelope for TMK UP Centum Specimen 1 Series B (90% Ambient)

	TEST: TMK UP CENTUM 13.375X72 P110			PG:
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Series B: Specimen 1 (100% Tension, 80% Compression)

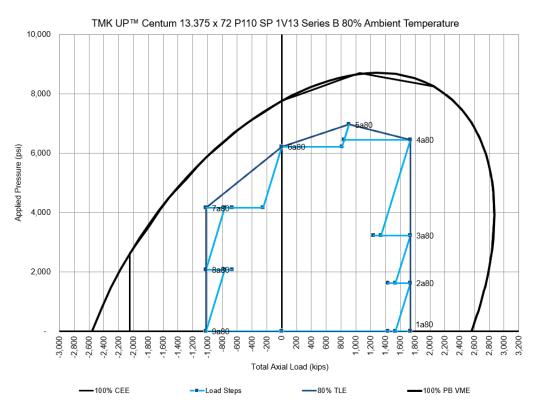


Figure 1-5: Test Envelope for TMK UP Centum Specimen 1 Series B (80% Ambient)

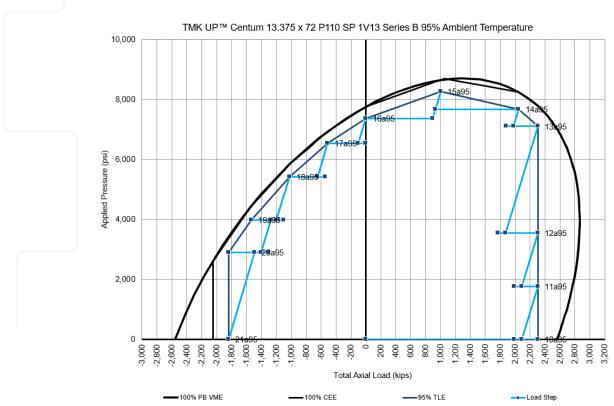


Figure 1-6: Test Envelope for TMK UP Centum Specimen 1 Series B (95% Ambient)

	TEST:			PG:
	TMK UP CENTUM 13.375X72 P110			1.8 of 1.10
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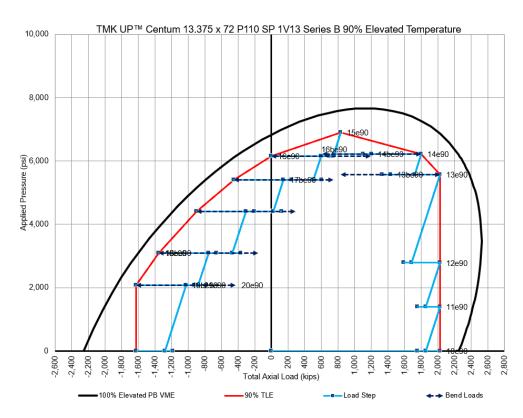


Figure 1-7: Test Envelope for TMK UP Centum Specimen 1 Series B (90% Elevated)

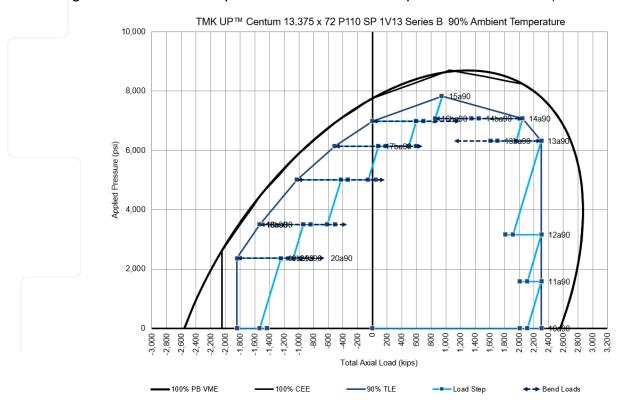


Figure 1-8: Test Envelope for TMK UP Centum Specimen 1 Series B (90% Ambient)

	TEST:			PG:
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Supplemental Testing

Not Applicable

Conclusion

The 13.375" x 72# P110 TMK UP Centum connection Specimen 1 was successfully qualified in accordance with API RP 5C5:2017 requirements per the test proposal TP PS-36-01-2018 Revision 4 with 100% tension and 80% compression efficiencies. The internal pressures correspond to 100% PBYS.

Approval Signatures		
Prepared By: Connection Test Engineer	Kevin Henry	 Date
Reviewed By: Design Engineer (EIC)	Alexey Prokofyev	 Date
Approved By: General Manager of R&D	 Dhiren Panda	 Date

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